U.S. PTO 11/727553 03/27/2007

orm PTO-1595 (Rev. 08/05) MB No. 0651-0027 (exp. 6/30/2008)	04-10-	2007		MENT OF COMMERCE
To the Director of the U.S. Patent ar.	10339	2658	Juments or the new a	ddress(es) below.
1. Name of conveying party(ies):		2. Name and addres	s of receiving party	ies)
David Pratt		Name: MICRON TECHNOLOGY, INC.		
		Internal Address:	•	
Additional name(s) of conveying party(les) attached?	Yes X No	Street Address:		
3. Nature of conveyance/Execution Date	(s):		•	
Execution Date(s): March 26, 2007		8000 S. Federal Way		
X Assignment Merger Ch	ange of Name			
Security Agreement Joint Resea	rch Agreement	City:	Boise_	
Government Interest Assignment		State:		
Executive Order 9424, Confirmatory License		Country: United States of America Zip: 83706-9632		
Other		Additional name(s) & attached?		es x No
Addition	nal numbers attached?	,	72753 no	
i. Name and address to whom correspond concerning document should be mailed		6. Total number of a patents involved:		1
Name: Thomas J. D'A DICKSTEIN SHAP	· · · · - · ·	7. Total fee (37 CFR	1.21(h) & 3.41) \$	40.00
Internal Address: Atty. Dkt.: M4065.1382/P1382		X Authorized to be charged by credit card		
Street Address: 1825 Eye Street, NW		Authorized	to be charged to depo	sit account
		Enclosed		
		None requir	ed (government intere	est not affecting title)
City: Washington		8. Payment Informa	tion	
State: DC Zi	p: 20006-5403	a. Credit Card	Last 4 Numbers	1002
Phone Number: (202) 420-			Expiration Date	01/11
Fax Number: (202) 420-2201 Email Address: DAmicoT@dicksteinshapiro.com		b. Deposit Account Authorized User		
	misnagiro.com	Authorized User	IVALLE	
9. Signature:	>		March 1	26, 2007
Sig	nature	83/2/	3/2007 JADDO1 Da	(6) 1017 11727333
Thomas J. D'Amico - 28,371		Total	number of pages include	ling cover 3/4).
Name of Person	Signing	sheet	attachments, and doc	uments:

DSMDB-2235083v01

REEL: 019148 FRAME: 0701

Docket No.: M4065,1382/P1382

ASSIGNMENT AND AGREEMENT

For value received, I, David Pratt, hereby sell, assign and transfer to Micron Technology, Inc., a corporation of the State of Delaware, having an office at 8000 S. Federal Way, Boise, Idaho 83706-9632, U.S.A., and its successors, assigns and legal representatives, the entire right, title and interest, for the United States of America, in and to certain inventions related to an invention entitled METHOD AND APPARATUS PROVIDING INTEGRATED CIRCUIT HAVING REDISTRIBUTION LAYER WITH RECESSED CONNECTORS, described in an application for Letters Patent of the United States, executed by me of even date herewith, and all the rights and privileges in said application and under any and all Letters Patent that may be granted in the United States for said inventions; and I also concurrently hereby sell, assign and transfer to Micron Technology, Inc. the entire right, title and interest in and to said inventions for all countries foreign to the United States, including all rights of priority arising from the application aforesaid, and all the rights and privileges under any and all forms of protection, including Letters Patent, that may be granted in said countries foreign to the United States for said inventions.

I authorize Micron Technology, Inc. to make application for such protection in its own name and maintain such protection in any and all countries foreign to the United States, and to invoke and claim for any application for patent or other form of protection for said inventions, without further authorization from me, any and all benefits, including the right of priority provided by any and all treaties, conventions, or agreements.

I hereby consent that a copy of this assignment shall be deemed a full legal and formal equivalent of any document which may be required in any country in proof of the right of Micron Technology, Inc. to apply for patent or other form of protection for said inventions and to claim the aforesaid benefit of the right of priority.

I request that any and all patents for said inventions be issued to Micron Technology, Inc. in the United States and in all countries foreign to the United States, or to such nominees as Micron Technology, Inc. may designate.

1

DSMDB-2222986v01

I agree that, when requested, I shall, without charge to Micron Technology, Inc. but at its expense, sign all papers, and do all acts which may be necessary, desirable or convenient in connection with said applications, patents, or other forms of protection.

David Pratt

Date: 3/26/07

> Notary Public Lxp: 2/20/2012

STAPLIES OF TOTAL

REEL: 019148 FRAME: 0703